

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chai Wei Heng	11/15/2005
Yang Hong Heng	11/15/2005
Yong Chern Poh	11/15/2005

RECEIVING PARTY DATA

Name:	Infineon Technologies AG
Street Address:	St.-Martin-Strasse 53
City:	Munich
State/Country:	GERMANY
Postal Code:	81669

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12046969

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:

INF 2005 P 52427 US

NAME OF SUBMITTER:

Nancy Milinkovich

Total Attachments: 3

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PATENT

REEL: 020641 FRAME: 0638

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ASSIGNMENT

WHEREAS, HENG Chai Wei, a citizen of Malaysia, of 569, Jalan Utama, Air Keroh Heights 75450 Melaka,

HENG Yang Hong, a citizen of Malaysia, of 162, Jalan Mawar 8, Taman Mawar, 84000 Muar, Johor,

POH Yong Chern, a citizen of Malaysia, of 26, Lorong Teratai 1, Taman Murni, Jalan Haji Jaib, 84000 Muar, Johor,

(hereinafter referred to as 'ASSIGNORS') have invented an improvement in METHOD OF MANUFACTURE OF ENCAPSULATED PACKAGE (file FP2699) and have executed a PCT application based thereon filed 25 October 2005 under application number PCT/SG2005/000368;

AND, WHEREAS, Infineon Technologies AG, a company organized and existing under the laws of Germany of St.-Martin-Strasse 53 81669 Munich Germany (hereinafter referred to as ASSIGNEE) is desirous of acquiring certain rights thereunder;

NOW, THEREFORE, for one Singapore dollar and other good and valuable consideration, receipt of all of which is hereby acknowledged, ASSIGNORS have agreed to and do hereby sell, assign and transfer unto said ASSIGNEE the entire right, title and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto in and to said invention, said PCT application, any United States applications (including provisional, non-provisional, divisional, continuing, or reissue applications) based in whole or in part on said PCT application or in whole or in part on said invention, any foreign applications based in whole or in part on the aforesaid PCT application or in whole or in part on said invention, and any and all patents (including extensions thereof) of any country which have been or may be granted on any of the aforesaid applications or on said invention or any part thereof;

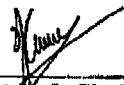
TO BE HELD AND ENJOYED by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had no sale and assignment of said interest been made;


AND ASSIGNORS hereby authorize and request the Commissioner of Patents of the United States of America to issue any and all United States patents which may be granted upon any United States patent applications based in whole or in part on the aforesaid PCT application, or upon said invention or any part thereof, to said ASSIGNEE;

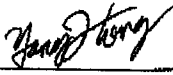
AND ASSIGNORS hereby jointly and severally agree for themselves and for their respective heirs, executors and administrators, to execute without further consideration any further lawful documents and any further assurances, and any provisional, non-provisional, divisional, continuing, reissue, or other applications for patents of any country, that may be deemed necessary by said ASSIGNEE fully to secure to said ASSIGNEE its interest as aforesaid in and to said invention or any part thereof, and in and to said several patents or any of them;

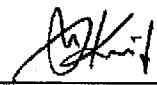
AND ASSIGNORS hereby jointly and severally covenant for themselves and their respective legal representatives that no right or license has been granted to make, use or sell said invention, to anyone except said ASSIGNEE, that prior to the execution of this agreement the right, title and interest in said invention had not been otherwise encumbered, and that no instrument will be executed in conflict herewith.


IN WITNESSETH thereof this agreement has been executed by ASSIGNORS and duly authorized representatives of ASSIGNEE.



Name: HENG Chai Wei
Date: 15/11/05


Witness: SEE Kian Kok


Name: HENG Yang Hong
Date: 15/Nov/05


Witness: SEE Kian Kok



Name: POH Yong Chern
Date: 15 NOV 05

Witness: SEE Kian Kok

For and on behalf of Infineon Technologies AG

Name:
Position:
Date:

Witness:

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